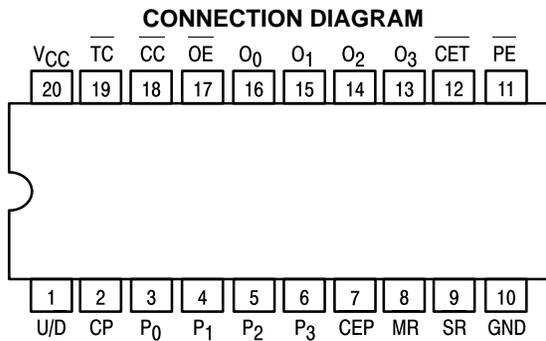




4-BIT BIDIRECTIONAL COUNTERS (WITH 3-STATE OUTPUTS)

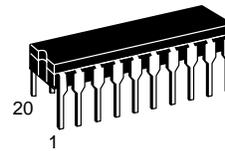
The MC54/74F568 and MC54/74F569 are fully synchronous, reversible counters with 3-state outputs. The F568 is a BCD decade counter; the F569 is a binary counter. They feature preset capability for programmable operation, carry lookahead for easy cascading, and a U/D input to control the direction of counting. For maximum flexibility there are both synchronous and master asynchronous reset inputs as well as both Clocked Carry (CC) and Terminal Count (TC) outputs. All state changes except Master Reset are initiated by the rising edge of the clock. A HIGH signal on the Output Enable (OE) input forces the output buffers into the high impedance state but does not prevent counting, resetting or parallel loading.

- 4-Bit Bidirectional Counting
 - F568 Decade Counter
 - F569 Binary Counter
- Synchronous Counting and Loading
- Lookahead Carry Capability for Easy Cascading
- Preset Capability for Programmable Operation
- 3-State Outputs for Bus Organized Systems
- Master Reset (MR) Overrides All Other Inputs
- Synchronous Reset (SR) Overrides Counting and Parallel Loading

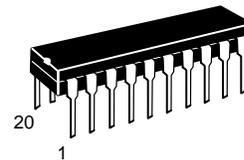


**MC54/74F568
MC54/74F569**

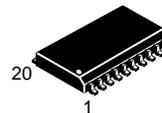
**4-BIT
BIDIRECTIONAL
COUNTERS
(WITH 3-STATE OUTPUTS)**
FAST™ SCHOTTKY TTL



**J SUFFIX
CERAMIC
CASE 732-03**



**N SUFFIX
PLASTIC
CASE 738-03**

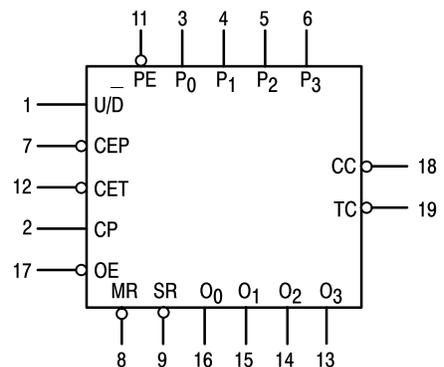


**DW SUFFIX
SOIC
CASE 751D-03**

ORDERING INFORMATION

MC54FXXXJ Ceramic
MC74FXXXN Plastic
MC74FXXXDW SOIC

LOGIC SYMBOL



MC54/74F568 • MC54/74F569

Symbol	Parameter	Min	Typ	Max	Unit	
V _{CC}	Supply Voltage	54, 74	4.5	5.0	5.5	V
T _A	Operating Ambient Temperature Range	54	-55	25	125	°C
		74	0	25	70	
I _{OH}	Output Current — High	54, 74			-3.0	mA
I _{OL}	Output Current — Low	54, 74			24	mA

FUNCTIONAL DESCRIPTION

The F568 counts modulo-10 in the BCD (8421) sequence. From state 9 (HLLH) it will increment to 0 (LLLL) in the Up mode; in Down mode it will decrement from 0 to 9. The F569 counts in the modulo-16 binary sequence. From state 15 it will increment to state 0 in the Up mode; in the Down mode it will decrement from 0 to 15. The clock inputs of all flip-flops are driven in parallel through a clock buffer. All state changes (except due to Master Reset) occur synchronously with the LOW-to-HIGH transition of the Clock Pulse (CP) input signal.

The circuits have five fundamental modes of operation, in order of precedence: asynchronous reset, synchronous reset, parallel load, count and hold. Five control inputs — Master Reset (MR), Synchronous Reset (SR), Parallel Enable (PE), Count Enable Parallel (CEP) and Count Enable Trickle (CET) — plus the Up/Down (U/D) input, determine the mode of operation, as shown in the Mode Select Table. A LOW signal on MR overrides all other inputs and asynchronously forces the flip-flop Q outputs LOW. A LOW signal on SR overrides counting and parallel loading and allows the Q outputs to go LOW on the next rising edge of CP. A LOW signal on PE overrides counting and allows information on the Parallel Data (P_n) inputs to be loaded into the flip-flops on the next rising edge of CP. With MR, SR and PE HIGH, CEP and CET permit counting when both are LOW. Conversely, a HIGH signal on either CEP or CET inhibits counting.

The F568 and F569 use edge-triggered flip-flops and changing the SR, PE, CEP, CET or U/D inputs when the CP is in either state does not cause errors, provided that the recommended setup and hold times, with respect to the rising edge of CP, are observed.

Two types of outputs are provided as overflow/underflow indicators. The Terminal Count (TC) output is normally HIGH and goes LOW providing CET is LOW, when the counter reaches zero in the Down mode, or reaches maximum (9 for the F568, 15 for the F569) in the Up mode. TC will then remain LOW until a state change occurs, whether by counting or pre-setting, or until U/D or CET is changed. To implement synchronous multistage counters, the connections between the TC output and the CEP and CET inputs can provide either slow or fast carry propagation. Figure A shows the connections for simple ripple carry, in which the clock period must be longer than the CP to TC delay of the first stage, plus the cumulative CET to TC delays of the intermediate stages, plus the CET to CP setup time of the last stage. This total delay plus setup time sets the upper limit on clock frequency. For faster clock rates, the carry lookahead connections shown in Figure B are recommended. In this scheme the ripple delay through the intermediate stages commences with the same clock that causes the first stage to tick over from max to min in the Up mode, or min to max in the Down mode, to start its final cycle. Since this final cycle takes 10 (F568) or 16 (F569) clocks to complete, there is plenty of time for the ripple to progress through the intermediate stages. The critical timing that limits the clock peri-

od is the CP to \overline{TC} delay of the first stage plus the \overline{CEP} to CP setup time of the last stage. The TC output is subject to decoding spikes due to internal race conditions and is therefore not recommended for use as a clock or asynchronous reset for flip-flops, registers or counters. For such applications, the Clocked Carry (CC) output is provided. The CC output is normally HIGH. When CEP, CET, and TC are LOW, the CC output will go LOW when the clock next goes LOW and will stay LOW until the clock goes HIGH again, as shown in the CC Truth Table. When the Output Enable (OE) is LOW, the parallel data outputs O₀–O₃ are active and follow the flip-flop Q outputs. A HIGH signal on OE forces O₀–O₃ to the High Z state but does not prevent counting, loading or resetting.

LOGIC EQUATIONS:

Count Enable = CEP · CET · PE

Up (F568): $\overline{TC} = Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3 \cdot (\text{Up}) \cdot \overline{CET}$

(F569): $\overline{TC} = Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3 \cdot (\text{Up}) \cdot \overline{CET}$

Down (Both): $\overline{TC} = Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3 \cdot (\text{Down}) \cdot \overline{CET}$

CC TRUTH TABLE

Inputs						Output
SR	PE	CEP	CET	TC*	CP	CC
L	X	X	X	X	X	H
X	L	X	X	X	X	H
X	X	H	X	X	X	H
X	X	X	H	X	X	H
X	X	X	X	H	X	H
H	H	L	L	L		

* = TC is generated internally

L = LOW Voltage Level

H = HIGH Voltage Level

X = Don't Care

 = Low Pulse

FUNCTION TABLE

Inputs							Operating Mode
MR	SR	PE	CEP	CET	U/D	CP	
L	X	X	X	X	X	X	Asynchronous reset
h	l	X	X	X	X	↑	Synchronous reset
h	h	l	X	X	X	↑	Parallel load
h	h	h	l	l	h	↑	Count up (increment)
h	h	h	l	l	l	↑	Count down (decrement)
h	H	H	H	X	X	X	Hold (do nothing)
h	H	H	X	H	X	X	

H = HIGH voltage level

h = HIGH voltage level one setup prior to the Low-to-High Clock transition

L = LOW voltage level

l = LOW voltage level one setup prior to the Low-to-High clock transition

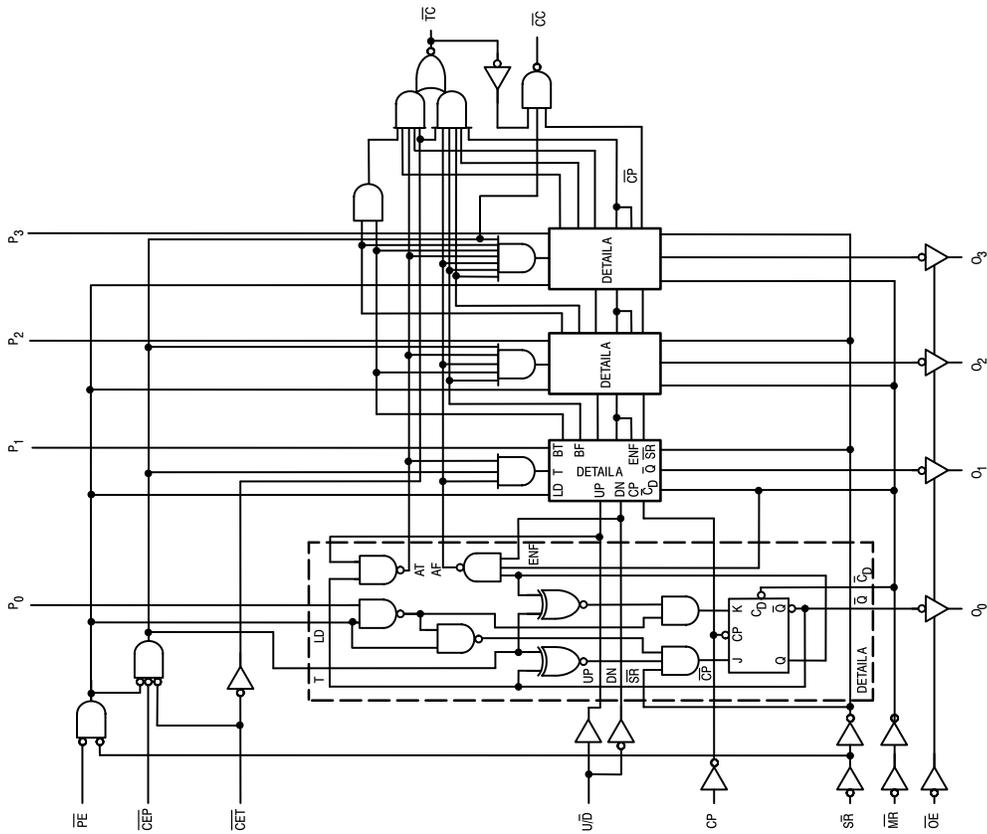
X = Don't care

↑ = Low-to-High clock transition

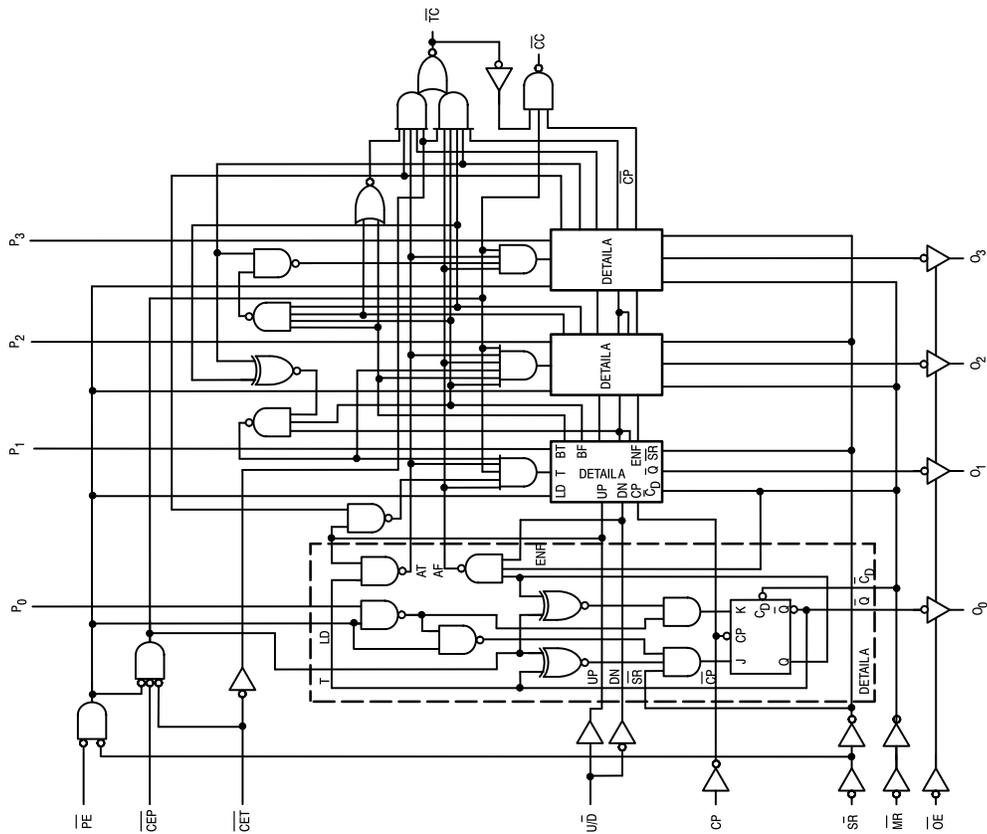
MC54/74F568 • MC54/74F569

LOGIC DIAGRAMS

MC54/74F569



MC54/74F568



Please note that these diagrams are provided only for the understanding of logic operations and should not be used to estimate propagation delays.

MC54/74F568 • MC54/74F569

Figure A. Multistage Counter with Ripple Carry

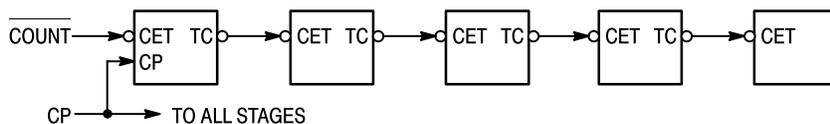
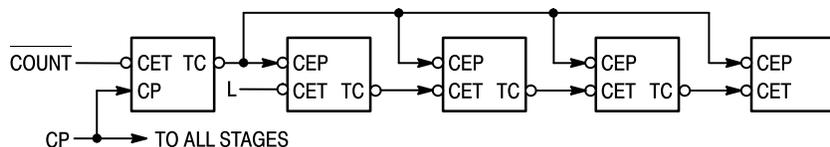


Figure B. Multistage Counter with Lookahead Carry



DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs
V _{IK}	Input Clamp Diode Voltage			-1.2	V	V _{CC} = MIN, I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	54, 74	2.4	3.3	V	I _{OH} = -3.0 mA, V _{CC} = 4.5 V
		74	2.7	3.3	V	I _{OH} = -3.0 mA, V _{CC} = 4.75 V
V _{OL}	Output LOW Voltage		0.3	0.5	V	I _{OL} = 24 mA, V _{CC} = MIN
I _{OZH}	Output OFF Current — HIGH			50	μA	V _{OUT} = 2.7 V, V _{CC} = MAX
I _{OZL}	Output OFF Current — LOW			-50	μA	V _{OUT} = 0.5 V, V _{CC} = MAX
I _{IH}	Input HIGH Current			20	μA	V _{IN} = 2.7 V, V _{CC} = MAX
				100		V _{IN} = 7.0 V, V _{CC} = MAX
I _{IL}	Input LOW Current PE, CET Others			-1.2 -0.6	mA	V _{CC} = MAX, V _{IN} = 0.5 V
I _{OS}	Output Short Circuit Current (Note 2)	-60		-150	mA	V _{OUT} = 0 V, V _{CC} = MAX
I _{CC}	Power Supply Current (ALL Outputs OFF)			67	mA	V _{CC} = MAX

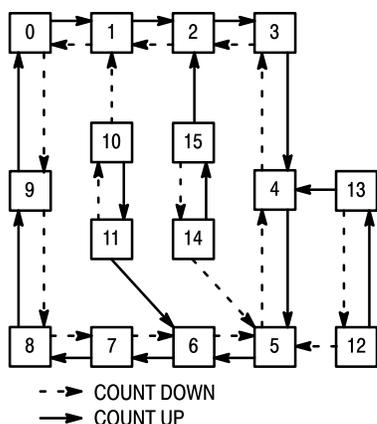
NOTES:

1. For conditions such as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Not more than one output should be shorted at a time, nor for more than 1 second.

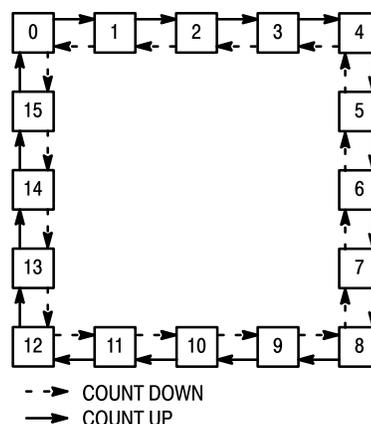
MC54/74F568 • MC54/74F569

STATE DIAGRAMS

MC54/74F568



MC54/74F569



AC CHARACTERISTICS

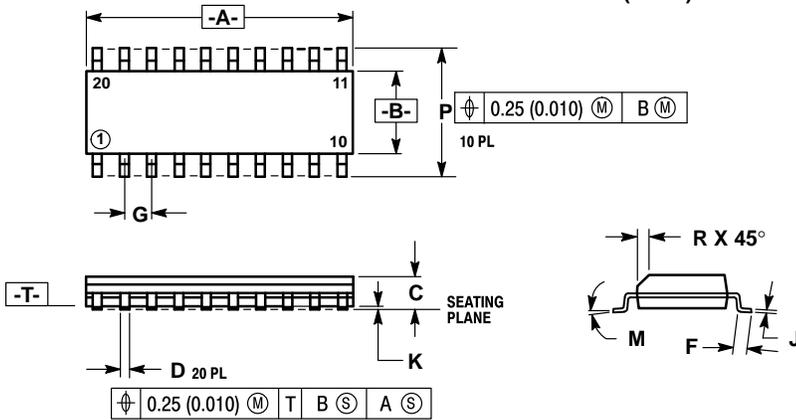
Symbol	Parameter	54/74F		54F		74F		Unit
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{ V}$ $C_L = 50\text{ pF}$		$T_A = -55\text{ to }+125^\circ\text{C}$ $V_{CC} = 5.0\text{ V} \pm 10\%$ $C_L = 50\text{ pF}$		$T_A = 0\text{ to }+70^\circ\text{C}$ $V_{CC} = 5.0\text{ V} \pm 10\%$ $C_L = 50\text{ pF}$		
		Min	Max	Min	Max	Min	Max	
f_{max}	Maximum Clock Frequency	100		60		85		MHz
t_{PLH} t_{PHL}	Propagation Delay CP to O_n (PE HIGH or LOW)	3.0 4.0	8.5 11.5	3.0 4.0	10.5 14	3.0 4.0	9.5 13	ns
t_{PLH} t_{PHL}	Propagation Delay CP to TC	5.5 4.0	15.5 11	5.5 4.0	18.5 13.5	5.5 4.0	17.5 12.5	ns
t_{PLH} t_{PHL}	Propagation Delay CET to TC	2.5 2.5	6.0 8.0	2.5 2.5	8.0 10	2.5 2.5	7.0 9.0	ns
t_{PLH} t_{PHL}	Propagation Delay U/D to TC ('F568)	3.5 4.0	11 16	3.5 4.0	13.5 19	3.5 4.0	12.5 18	ns
t_{PLH} t_{PHL}	Propagation Delay U/D to TC ('F569)	3.5 4.0	11 10.5	3.5 4.0	13.5 13	3.5 4.0	12.5 12	ns
t_{PLH} t_{PHL}	Propagation Delay CP to CC	2.5 2.0	7.0 6.0	2.5 2.0	9.0 8.0	2.5 2.0	8.0 7.0	ns
t_{PLH} t_{PHL}	Propagation Delay CEP, CET to CC	2.5 4.0	6.5 11	2.5 4.0	8.5 13.5	2.5 4.0	7.5 12.5	ns
t_{PHL}	Propagation Delay MR to O_n	5.0	13	5.0	15.5	5.0	14.5	ns
t_{PZH} t_{PZL}	Output Enable Time OE to O_n	2.5 3.0	7.0 8.0	2.5 3.0	9.0 10	2.5 3.0	8.0 9.0	ns
t_{PHZ} t_{PLZ}	Output Disable Time OE to O_n	1.5 2.0	6.5 6.0	1.5 2.0	8.5 8.0	1.5 2.0	7.5 7.0	ns

MC54/74F568 • MC54/74F569

AC OPERATING REQUIREMENTS

Symbol	Parameter	54/74F		54F		74F		Unit
		T _A = +25°C V _{CC} = +5.0 V		T _A = -55°C to +125°C V _{CC} = 5.0 V ±10%		T _A = 0°C to +70°C V _{CC} = 5.0 V ±10%		
		Min	Max	Min	Max	Min	Max	
t _S (H) t _S (L)	Setup Time, HIGH or LOW P _n to CP	4.0 4.0		5.5 5.5		4.5 4.5		ns
t _H (H) t _H (L)	Hold Time, HIGH or LOW P _n to CP	3.0 3.0		3.5 3.5		3.5 3.5		
t _S (H) t _S (L)	Setup Time, HIGH or LOW CEP or CET to CP	5.0 5.0		7.0 7.0		6.0 6.0		ns
t _H (H) t _H (L)	Hold Time, HIGH or LOW CEP or CET to CP	0 0		0 0		0 0		
t _S (H) t _S (L)	Setup Time, HIGH or LOW PE to CP	8.0 8.0		10 10		9.0 9.0		ns
t _H (H) t _H (L)	Hold Time, HIGH or LOW PE to CP	0 0		0 0		0 0		
t _S (H) t _S (L)	Setup Time, HIGH or LOW U/D to CP (F568)	11 16.5		13.5 18.5		12.5 17.5		ns
t _S (H) t _S (L)	Setup Time, HIGH or LOW U/D to CP (F569)	11 7.0		13.5 10		12.5 8.0		ns
t _H (H) t _H (L)	Hold Time, HIGH or LOW U/D to CP	0 0		0 0		0 0		ns
t _S (H) t _S (L)	Setup Time, HIGH or LOW SR to CP	10 8.0		12 10.5		11 9.5		ns
t _H (H) t _H (L)	Hold Time, HIGH or LOW SR to CP	0 0		0 0		0 0		
t _w (H) t _w (L)	CP Pulse Width HIGH or LOW	4.0 6.0		6.0 8.0		4.5 6.5		ns
t _w (L)	MR Pulse Width, LOW	4.5		6.0		5.0		ns
t _{rec}	MR Recovery Time	6.0		8.0		7.0		ns

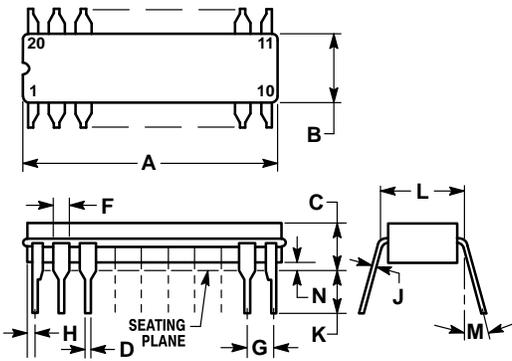
**Case 751D-03 DW Suffix
20-Pin Plastic
SO-20 (WIDE)**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. 751D-01, AND -02 OBSOLETE, NEW STANDARD 751D-03.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.65	12.95	0.499	0.510
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC	0.050 BSC		
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

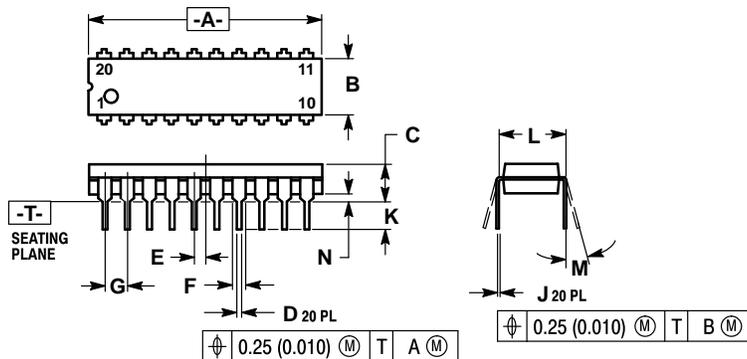
**Case 732-03 J Suffix
20-Pin Ceramic Dual In-Line**



- NOTES:
1. LEADS WITHIN 0.25 mm (0.010) DIA., TRUE POSITION AT SEATING PLANE, AT MAXIMUM MATERIAL CONDITION.
 2. DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 3. DIM A AND B INCLUDES MENISCUS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	23.88	25.15	0.940	0.990
B	6.60	7.49	0.260	0.295
C	3.81	5.08	0.150	0.200
D	0.38	0.56	0.015	0.022
F	1.40	1.65	0.055	0.065
G	2.54 BSC	0.100 BSC		
H	0.51	1.27	0.020	0.050
J	0.20	0.30	0.008	0.012
K	3.18	4.06	0.125	0.160
L	7.62 BSC	0.300 BSC		
M	0°	15°	0°	15°
N	0.25	1.02	0.010	0.040

**Case 738-03 N Suffix
20-Pin Plastic**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION "L" TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
 5. 738-02 OBSOLETE, NEW STANDARD 738-03.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	25.66	27.17	1.010	1.070
B	6.10	6.60	0.240	0.260
C	3.81	4.57	0.150	0.180
D	0.39	0.55	0.015	0.022
E	1.27 BSC	0.050 BSC		
F	1.27	1.77	0.050	0.070
G	2.54 BSC	0.100 BSC		
J	0.21	0.38	0.008	0.015
K	2.80	3.55	0.110	0.140
L	7.62 BSC	0.300 BSC		
M	0°	15°	0°	15°
N	0.51	1.01	0.020	0.040

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